



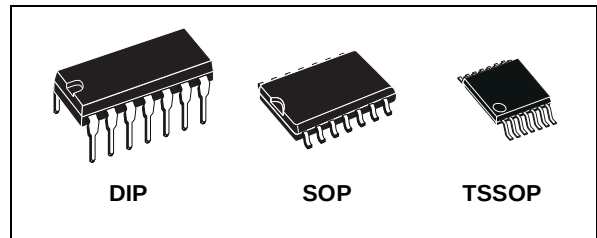
M74HC4066

QUAD BILATERAL SWITCH

- HIGH SPEED:
 $t_{PD} = 7ns$ (TYP.) at $V_{CC} = 6V$
- LOW POWER DISSIPATION:
 $I_{CC} = 1\mu A$ (MAX.) at $T_A = 25^\circ C$
- LOW "ON" RESISTANCE:
 $R_{ON} = 50\Omega$ TYP. AT $V_{CC} = 9V$, $I_{I/O} = 100\mu A$
- WIDE OPERATING VOLTAGE RANGE
 V_{CC} (OPR) = 2V TO 12V
- SINE WAVE DISTORTION:
0.042% at $V_{CC} = 4V$ $f = 1KHz$
- HIGH NOISE IMMUNITY:
 $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (MIN.)
- PIN AND FUNCTION COMPATIBLE WITH
74 SERIES 4066

DESCRIPTION

The M74HC4066 is an high speed CMOS QUAD BILATERAL SWITCH fabricated with silicon gate C²MOS technology.

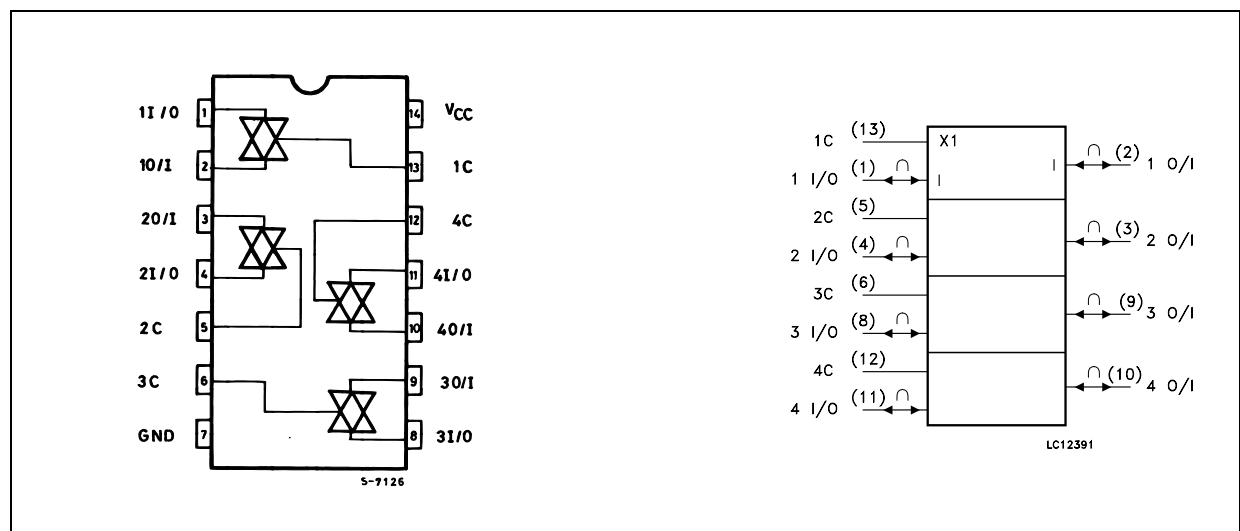


ORDER CODES

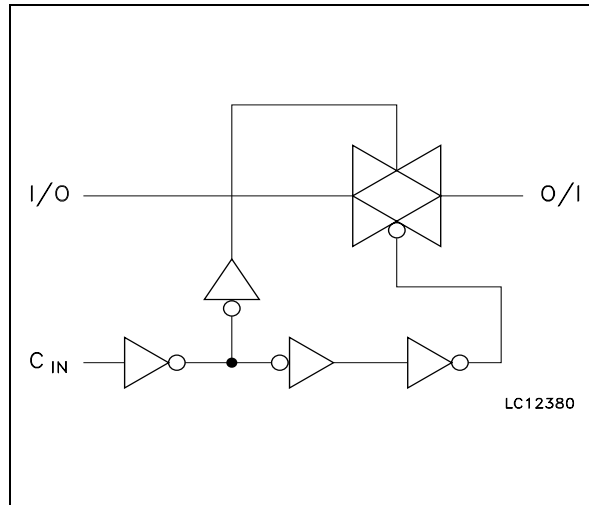
PACKAGE	TUBE	T & R
DIP	M74HC4066B1R	
SOP	M74HC4066M1R	M74HC4066RM13TR
TSSOP		M74HC4066TTR

The C input is provided to control the switch; the switch is on when the C input is held high and off when C is held low.

PIN CONNECTION AND IEC LOGIC SYMBOLS



LOGIC DIAGRAM



PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1, 4, 8, 11	1 to 4 I/O	Independent Inputs/Outputs
2, 3, 9, 10	1 to 4 O/I	Independent Outputs/Inputs
13, 5, 6, 12	1C to 4C	Enable Inputs (Active High)
7	GND	Ground (0V)
14	V _{CC}	Positive Supply Voltage

TRUTH TABLE

CONTROL	SWITCH FUNCTION
H	ON
L	OFF

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	-0.5 to +13	V
V _{IN}	DC Input Voltage	-0.5 to V _{CC} + 0.5	V
V _{I/O}	DC Input/Output Voltage	-0.5 to V _{CC} + 0.5	V
I _{OK}	Control Input DC Diode Current	± 20	mA
I _{I/O}	I/O DC Diode Current	± 20	mA
I _O	DC Output Source Sink Current Per Output Pin	± 25	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current	± 50	mA
P _D	Power Dissipation	500(*)	mW
T _{stg}	Storage Temperature	-65 to +150	°C
T _L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

(*) 500mW at 65 °C; derate to 300mW by 10mW/°C from 65°C to 85°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	2 to 12	V
V _{IN}	Input Voltage (Control)	0 to V _{CC}	V
V _{I/O}	I/O Voltage	0 to V _{CC}	V
T _{op}	Operating Temperature	-55 to 125	°C
t _r , t _f	Input Rise and Fall Time	V _{CC} = 2.0V	0 to 1000
		V _{CC} = 4.5V	0 to 500
		V _{CC} = 6.0V	0 to 400
		V _{CC} = 10.0V	0 to 250

DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value						Unit	
		V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.
V _{IHC}	High Level Control Input Voltage	2.0		1.5			1.5		1.5		V
		4.5		3.15			3.15		3.15		
		9.0		6.3			6.3		6.3		
		12.0		8.4			8.4		8.4		
V _{ILC}	Low Level Control Input Voltage	2.0				0.5		0.5		0.5	V
		4.5				1.35		1.35		1.35	
		9.0				2.7		2.7		2.7	
		12.0				3.6		3.6		3.6	
R _{ON}	ON Resistance	4.5	V _I = V _{IHC} V _{I/O} = V _{CC} to GND I _{I/O} ≤ 1mA		96	170		200		250	Ω
		9.0			55	85		100		150	
		12.0			45	80		90		120	
		4.5	V _I = V _{IHC} V _{I/O} = V _{CC} or GND I _{I/O} ≤ 1mA		70	100		130		160	
		9.0			50	75		95		115	
		12.0			45	70		90		110	
ΔR _{ON}	Difference of ON Resistance between switches	4.5	V _I = V _{IHC} V _{I/O} = V _{CC} or GND I _{I/O} ≤ 1mA		10					Ω	
		9.0			5						
		12.0			5						
I _{OFF}	Input/Output Leakage Current (SWITCH OFF)	12.0	V _{OS} = V _{CC} or GND V _{IS} = V _{CC} or GND V _{IN} = V _{ILC}			± 0.1		± 1		± 2	μA
I _{IZ}	Switch Input Leakage Current (SWITCH ON, OUTPUT OPEN)	12.0	V _{OS} = V _{CC} or GND V _{IN} = V _{IHC}			± 0.1		± 1		± 2	μA
I _{IN}	Control Input Current	6.0	V _I = V _{CC} or GND			± 0.1		± 1		± 1	μA
I _{CC}	Quiescent Supply Current	6.0	V _I = V _{CC} or GND			1		10		20	μA
		9.0				4		40		80	
		12.0				8		80		160	

AC ELECTRICAL CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

Symbol	Parameter	Test Condition		Value						Unit	
		V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.
Φ _{I/O}	Phase Difference Between Input and Output	2.0			10	50		65		75	ns
		4.5			4	10		13		15	
		9.0			3	8		10		13	
		12.0			3	7		9		10	
t _{PZL} t _{PZH}	Output Enable Time	2.0	R _L = 1KΩ		18	100		125		150	ns
		4.5			8	20		25		30	
		9.0			6	12		22		27	
		12.0			6	12		18		25	
t _{PLZ} t _{PHZ}	Output Disable Time	2.0	R _L = 1KΩ		20	115		145		175	ns
		4.5			10	23		29		35	
		9.0			8	20		25		30	
		12.0			8	18		22		27	
	Maximum Control Input Frequency	2.0	R _L = 1KΩ C _L = 15 pF V _{OUT} = 1/2 V _{CC}		30						MHz
		4.5			30						
		9.0			30						
		12.0			30						

CAPACITIVE CHARACTERISTICS

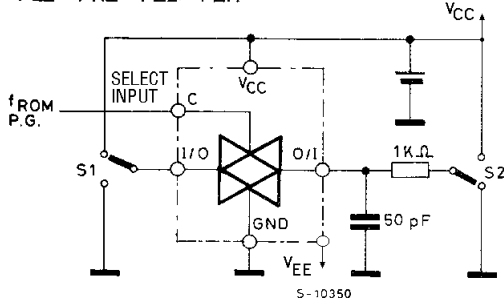
Symbol	Parameter	Test Condition		Value						Unit	
		V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.
C _{IN}	Input Capacitance				5	10		10		10	pF
C _{I/O}	Switch Terminal Capacitance				6						pF
C _{IOS}	Feed Through Capacitance				0.5						pF
C _{PD}	Power Dissipation Capacitance (note 1)				15						pF

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$

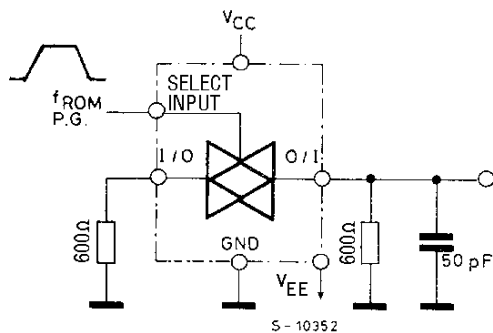
ANALOG SWITCH CHARACTERISTICS (GND = 0V; $T_A = 25^\circ\text{C}$)

Symbol	Parameter	Test Condition		Value	Unit
		V_{CC} (V)	V_{IN} (V_{p-p})	Typ.	
	Sine Wave Distortion (THD)	4.5	4	0.05	%
		9.0	8	0.04	
f_{MAX}	Frequency Response (Switch ON)	4.5	Adjust f_{IN} voltage to obtain 0 dBm at V_{OS} . Increase f_{IN} Frequency until dB meter reads -3dB $R_L = 50\Omega$, $C_L = 10$ pF	200	MHz
		9.0		200	
	Feed through Attenuation (Switch OFF)	4.5	V_{IN} is centered at $V_{CC}/2$. Adjust input for 0 dBm $R_L = 600\Omega$, $C_L = 50$ pF, $f_{IN} = 1$ MHz sine wave	-60	dB
		9.0		-60	
	Crosstalk (Control Input to Signal Output)	4.5	$R_L = 600\Omega$, $C_L = 50$ pF, $f_{IN} = 1$ MHz square wave ($t_r = t_f = 6$ ns)	60	mV
		9.0		100	
	Crosstalk (Between Any Switches)	4.5	Adjust V_{IN} to Obtain 0 dBm at input $R_L = 600\Omega$, $C_L = 50$ pF, $f_{IN} = 1$ MHz sine wave	-60	dB
		9.0		-60	

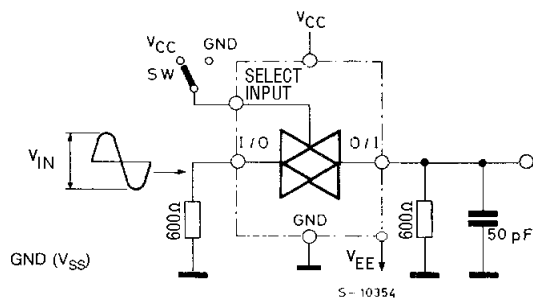
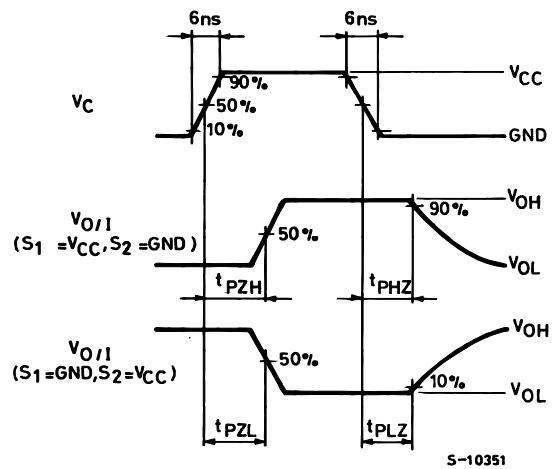
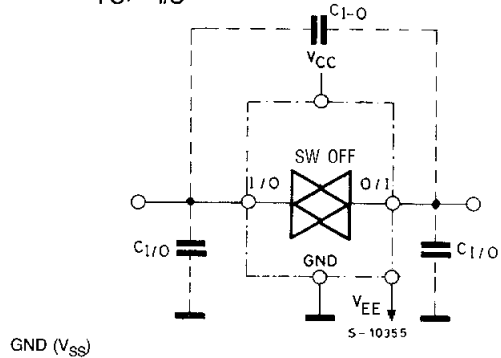
SWITCHING CHARACTERISTICS TEST CIRCUIT

 t_{PLZ} , t_{PHZ} , t_{PZL} , t_{PZH} 

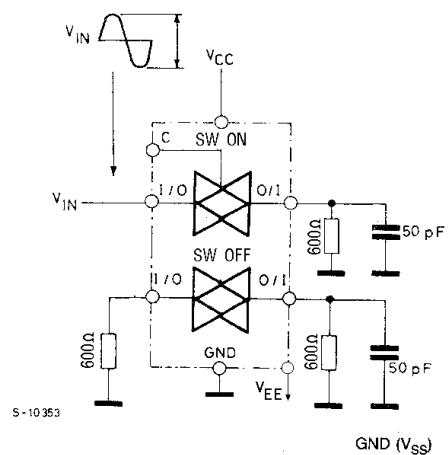
CROSSTALK (control to output)



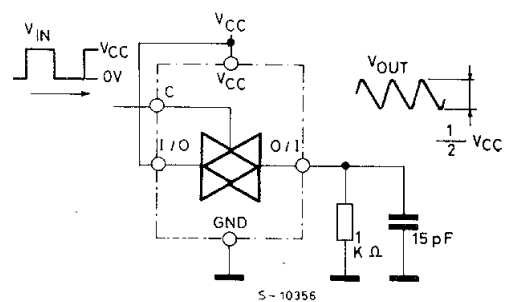
BANDWIDTH AND FEEDTHROUGH ATTENUATION

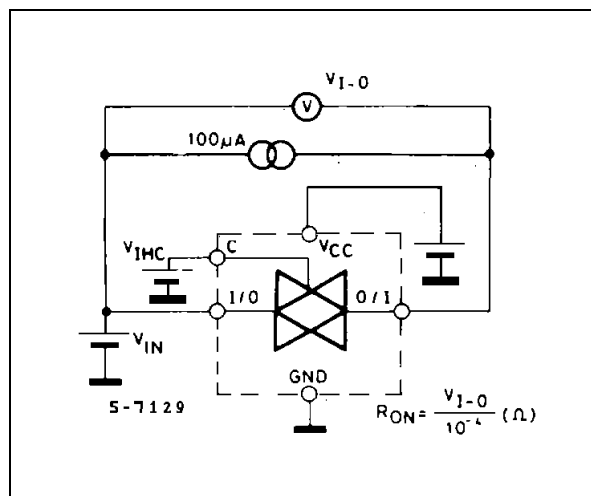
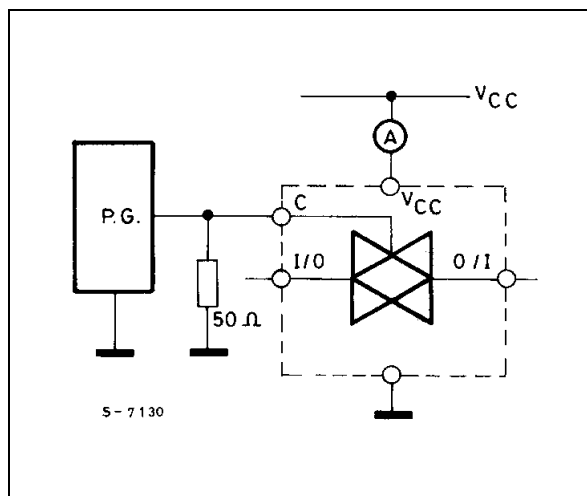
 C_{I-O} , $C_{I/O}$ 

CROSSTALK BETWEEN ANY TWO SWITCHES



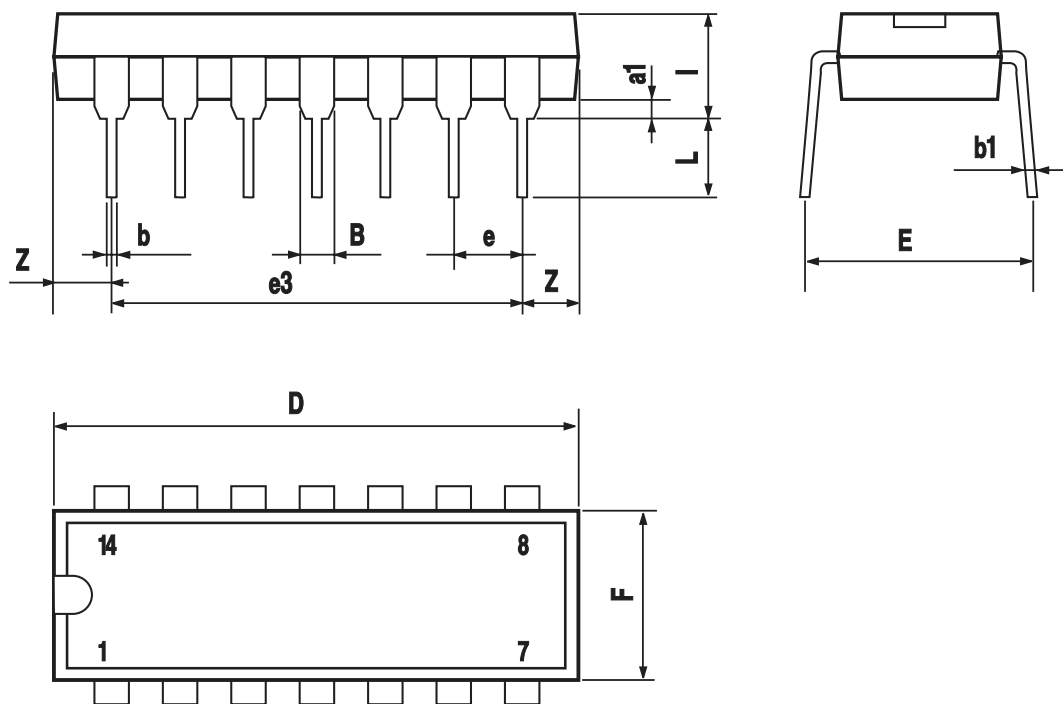
MAXIMUM CONTROL FREQUENCY



CHANNEL RESISTANCE (R_{ON}) I_{CC} (Opr.)

Plastic DIP-14 MECHANICAL DATA

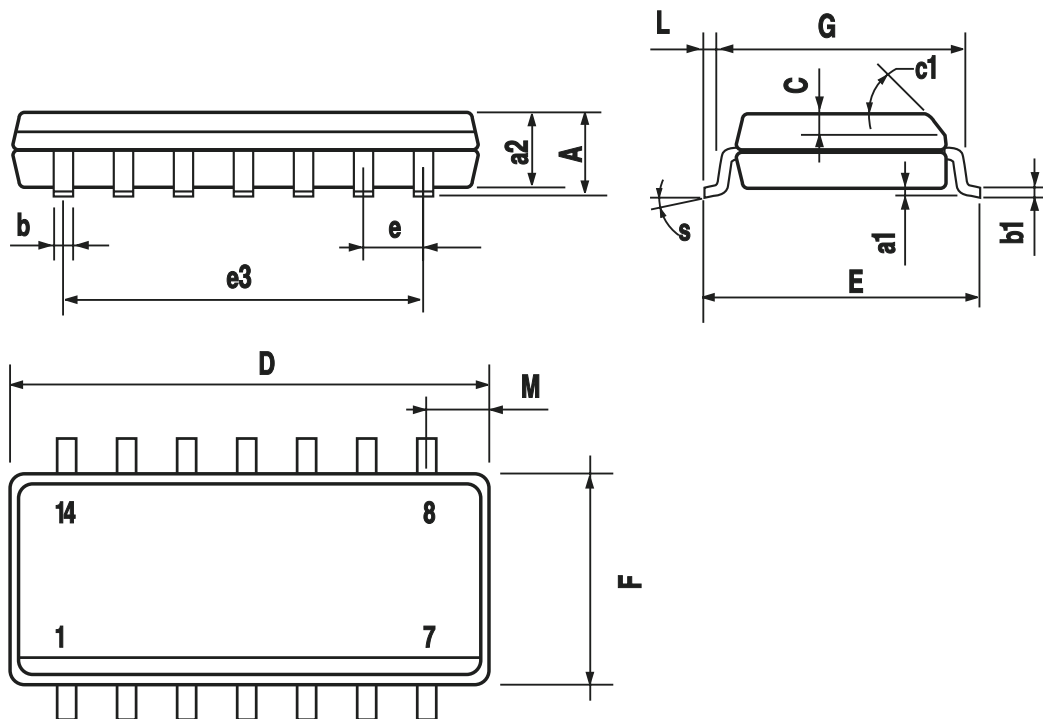
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



P001A

SO-14 MECHANICAL DATA

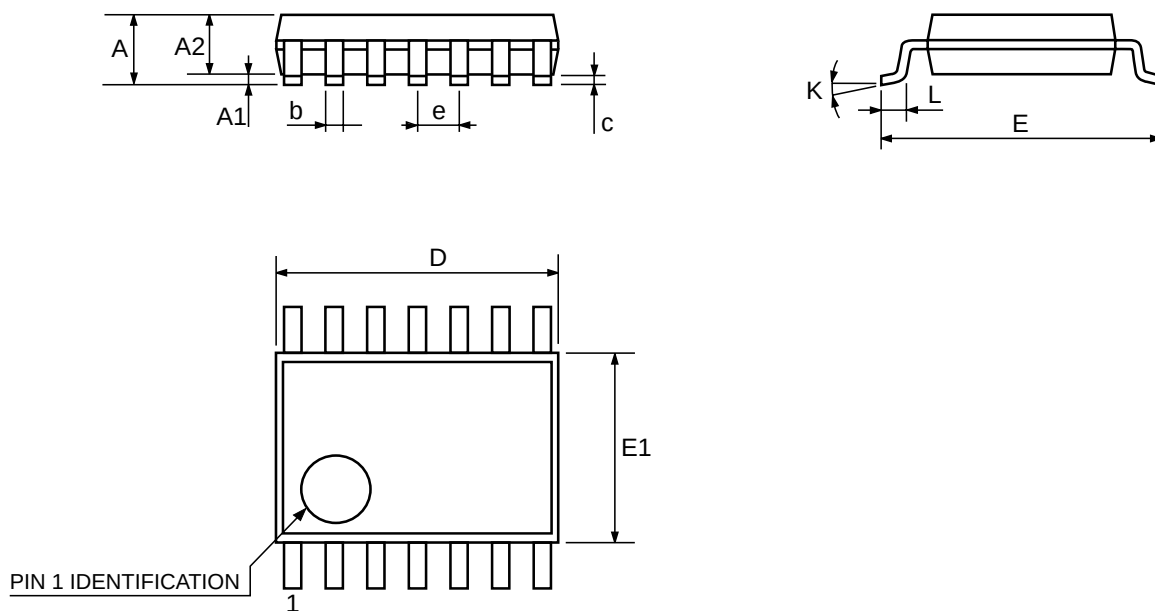
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					



PO13G

TSSOP14 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



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